Photocouplers Photorelay

# TLP3109

#### 1. Applications

- Mechanical relay replacements
- Security Systems
- Measuring Instruments
- Factory Automation (FA)
- Amusement Equipment

#### 2. General

The TLP3109 photorelay consists of a photo MOSFET optically coupled to an infrared LED. It is housed in a 2.54SOP6 package. The low ON-state resistance and the high permissible ON-state current of the TLP3109 make it suitable for power line control applications.

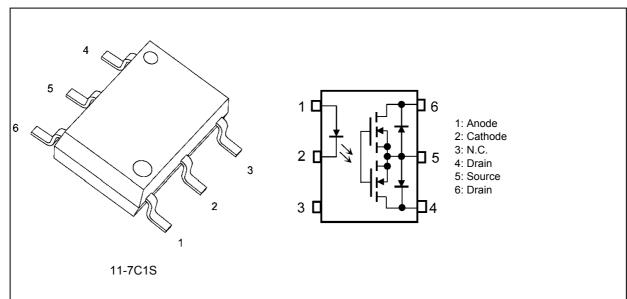
#### 3. Features

- (1) Normally opened (1-Form-A)
- (2) OFF-state output terminal voltage: 100 V (min)
- (3) Trigger LED current: 3 mA (max)
- (4) ON-state current: 2.0 A (max) (A connection)
- (5) ON-state resistance: 70 m $\Omega$  (max) (A connection)
- (6) Isolation voltage: 1500 Vrms (min)
- (7) Safety standards

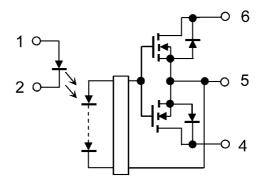
UL-recognized: UL 1577, File No.E67349

cUL-recognized: CSA Component Acceptance Service No.5A File No.E67349

#### 4. Packaging and Pin Assignment



#### 5. Internal Circuit



#### 6. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25 °C)

	Characteristics	Symbol	Note	Rating	Unit	
LED	Input forward current		I <sub>F</sub>		30	mA
	Input forward current derating	$(T_a \ge 25 \ ^\circ C)$	$\Delta I_F / \Delta T_a$		-0.3	mA/°C
	Input forward current (pulsed)	(100 µs pulse, 100 pps)	I <sub>FP</sub>		1	A
	Input reverse voltage		V <sub>R</sub>		5	V
	Input power dissipation		PD		50	mW
	Input power dissipation derating	(T <sub>a</sub> ≥ 25 °C)	$\Delta P_D / \Delta T_a$		-0.5	mW/°C
	Junction temperature		Тj		125	°C
Detector	OFF-state output terminal voltage		V <sub>OFF</sub>		100	V
	ON-state current (A connection)	I <sub>ON</sub>	(Note 1)	2.0	A	
	ON-state current (B connection)	I <sub>ON</sub>	(Note 1)	2.0		
	ON-state current (C connection)		I <sub>ON</sub>	(Note 1)	4.0	
	ON-state current derating (A connection)	(T <sub>a</sub> ≥ 25 °C)	$\Delta I_{ON} / \Delta T_a$	(Note 1)	-20	mA/°C
	ON-state current derating (B connection)	$(T_a \ge 25 \ ^\circ C)$	$\Delta I_{ON} / \Delta T_a$	(Note 1)	-20	
	ON-state current derating (C connection)	$(T_a \ge 25 \ ^\circ C)$	$\Delta I_{ON} / \Delta T_a$	(Note 1)	-40	
	ON-state current (pulsed)	(t = 100 ms, Duty = 1/10)	I <sub>ONP</sub>		6	А
	Output power dissipation		Po		400	mW
	Output power dissipation derating	(T <sub>a</sub> ≥ 25 °C)	$\Delta P_0 / \Delta T_a$		-4.0	mW/°C
	Junction temperature		Тj		125	°C
Common	Storage temperature		T <sub>stg</sub>		-55 to 125	
	Operating temperature		T <sub>opr</sub>		-40 to 85	]
	Lead soldering temperature	(10 s)	T <sub>sol</sub>		260	]
	Isolation voltage	AC, 60 s, R.H. $\leq$ 60 %	BV <sub>S</sub>	(Note 2)	1500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: For an application circuit example, see Chapter 12.2.

Note 2: This device is considered as a two-terminal device: Pins 1, 2 and 3 are shorted together, and pins 4, 5 and 6 are shorted together.

#### 7. Recommended Operating Conditions (Note)

Characteristics	Symbol	Note	Min	Тур.	Max	Unit
Supply voltage	V <sub>DD</sub>		_	—	80	V
Input forward current	١ <sub>F</sub>		5	10	25	mA
ON-state current (A connection)	I <sub>ON</sub>		_	_	2.0	А
Operating temperature	T <sub>opr</sub>		-20	_	65	°C

Note: The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this data sheet should also be considered.

#### 8. Electrical Characteristics (Unless otherwise specified, $T_a = 25$ °C)

	Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
LED	Input forward voltage	V <sub>F</sub>		I <sub>F</sub> = 10 mA	1.18	1.33	1.48	V
	Input reverse current	I <sub>R</sub>		V <sub>R</sub> = 5 V			10	μA
	Input capacitance	Ct		V = 0 V, f = 1 MHz	_	70	—	pF
Detector	OFF-state current	I <sub>OFF</sub>		V <sub>OFF</sub> = 100 V	_	—	1	μA
				V <sub>OFF</sub> = 80 V	_	_	20	nA
	Output capacitance	C <sub>OFF</sub>		V = 0 V, f = 1 MHz		500		pF

#### 9. Coupled Electrical Characteristics (Unless otherwise specified, T<sub>a</sub> = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I <sub>FT</sub>		I <sub>ON</sub> = 100 mA	—	0.4	3	mA
Return LED current	I <sub>FC</sub>		I <sub>OFF</sub> = 10 μA	0.1	—	_	
ON-state resistance (A connection)	R <sub>ON</sub>	(Note 1)	I <sub>ON</sub> = 2.0 A, I <sub>F</sub> = 5 mA, t < 1 s	_	45	70	mΩ
ON-state resistance (B connection)				—	22	35	
ON-state resistance (C connection)			I <sub>ON</sub> = 4.0 A, I <sub>F</sub> = 5 mA, t < 1 s	_	11	18	

Note 1: For an application circuit example, see Chapter 12.2.

#### 10. Isolation Characteristics (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Total capacitance (input to output)	Cs	(Note 1)	V <sub>S</sub> = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation resistance	R <sub>S</sub>	(Note 1)	$V_S$ = 500 V, R.H. $\leq$ 60 %	$5  imes 10^{10}$	10 <sup>14</sup>	_	Ω
Isolation voltage	BVS	(Note 1)	AC, 60 s	1500	_	_	Vrms

Note 1: This device is considered as a two-terminal device: Pins 1, 2 and 3 are shorted together, and pins 4, 5 and 6 are shorted together.

#### 11. Switching Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Turn-on time	t <sub>ON</sub>		See Fig. 11.1. R <sub>L</sub> = 200 Ω, V <sub>DD</sub> = 20 V, I <sub>F</sub> = 5 mA	_	1.1	5.0	ms
			See Fig. 11.1. R <sub>L</sub> = 200 Ω, V <sub>DD</sub> = 20 V, I <sub>F</sub> = 10 mA	_	0.6	3.0	
Turn-off time	t <sub>OFF</sub>		See Fig. 11.1. R <sub>L</sub> = 200 Ω, V <sub>DD</sub> = 20 V, I <sub>F</sub> = 5 mA	_	0.1	1.0	
			See Fig. 11.1. $R_L = 200 \ \Omega, V_{DD} = 20 \ V, I_F = 10 \ mA$	_	0.1	1.0	

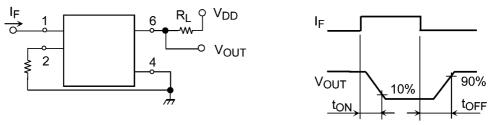


Fig. 11.1 Switching Time Test Circuit and Waveform

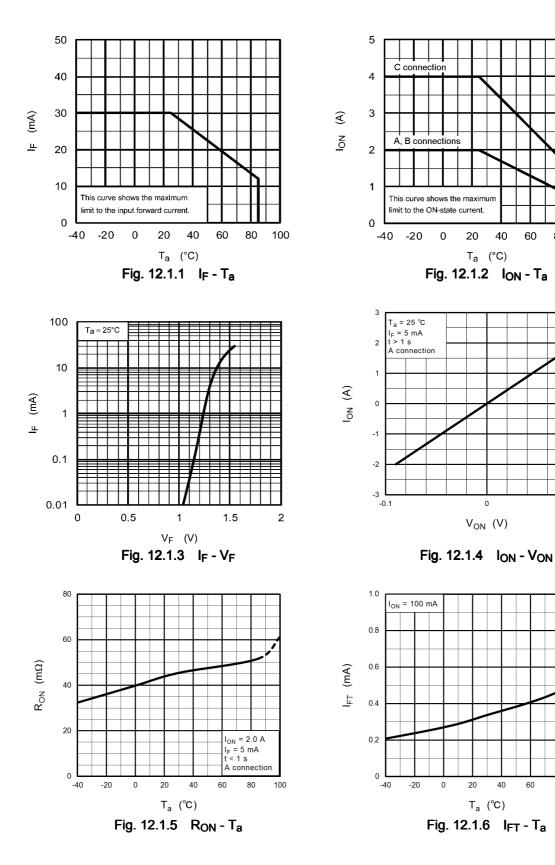
80

100

0.1

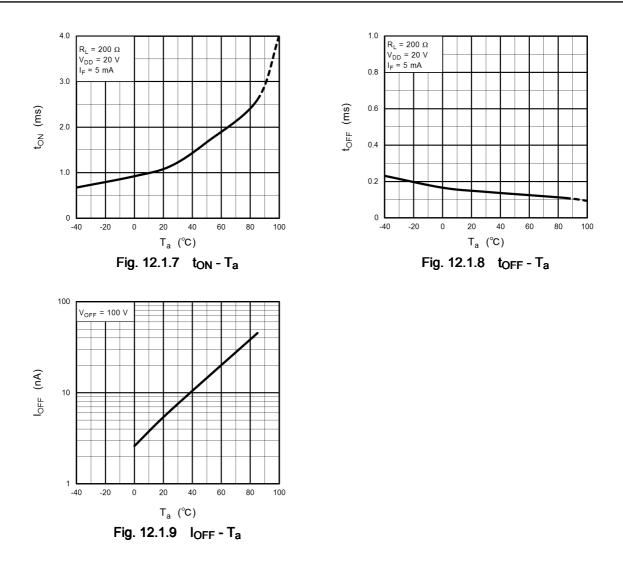
#### 12. Characteristics Curves and Circuit Connections

#### 12.1. Characteristics Curves (Note)



80

100



Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

#### 12.2. Circuit Connections

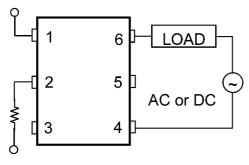


Fig. 12.2.1 A Connection

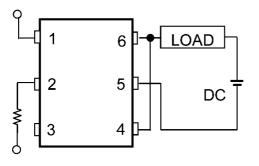


Fig. 12.2.3 C Connection

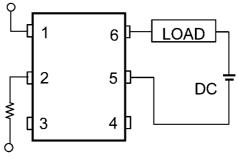
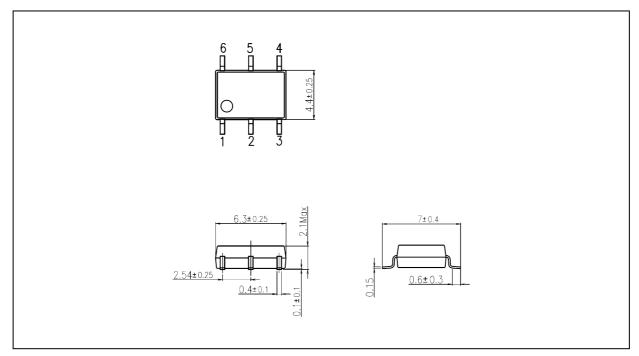


Fig. 12.2.2 B Connection

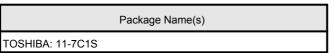
### TLP3109

#### Package Dimensions

Unit: mm



Weight: 0.13 g (typ.)



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